

Part Number: XZM2ACY79W

3.8x2.0mm DOME LENS SMD CHIP LED LAMP

Features

• Ideal for indication light on hand held products

• Long life and robust package

• Variety of lens types and color choices available

ullet Package : 500pcs / reel

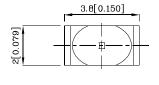
• Moisture sensitivity level : level 3

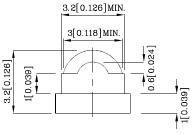
• RoHS compliant

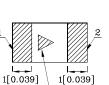




Package Schematics







POLARITY MARK

Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.2(0.008")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T _A =25°C)	M2ACY (AlGaInP)	Unit		
Reverse Voltage	V_{R}	5	V	
Forward Current	I_{F}	30	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	$i_{\rm FS}$	140	mA	
Power Dissipation	P_{D}	75	mW	
Operating Temperature	T_{A}	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +85	C	

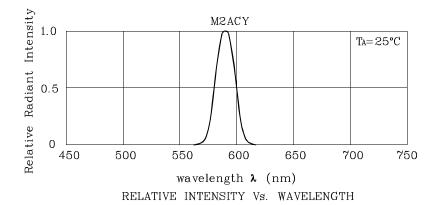
Operating Characteristics (T _A =25°C)		M2ACY (AlGaInP)	Unit
Forward Voltage (Typ.) (I _F =20mA)	V_{F}	2	V
Forward Voltage (Max.) (I _F =20mA)	V_{F}	2.5	V
Reverse Current (Max.) (V _R =5V)	I_R	10	uA
Wavelength of Peak Emission (Typ.) (I _F =20mA)	λΡ	590	nm
Wavelength of Dominant Emission (Typ.) (I _F =20mA)	λD	589	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =20mA)	$\triangle \lambda$	20	nm
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	45	pF

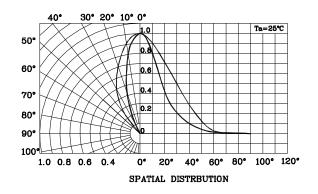
Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (I _F =20mA) mcd		Wavelength nm λP	Viewing Angle 20 1/2
				min.	typ.		
XZM2ACY79W	Yellow	AlGaInP	Water Clear	700	1295	590	60°(H) 35°(V)

Apr 13,2011 XDSB2805 V2 Layout: Maggie L.

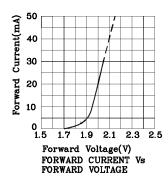


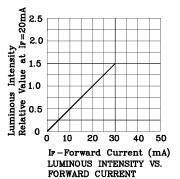


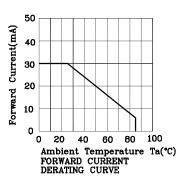


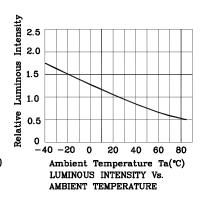


❖ M2ACY



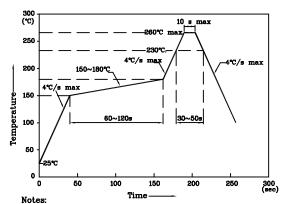






LED is recommended for reflow soldering and soldering profile is shown below.

Reflow Soldering Profile for SMD Products (Pb-Free Components)



- 1. Maximum soldering temperature should not exceed 260°C
- 2. Recommended reflow temperature: 145°C-260°C
- 3. Do not put stress to the epoxy resin during high temperatures conditions

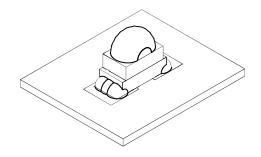
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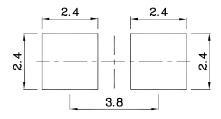




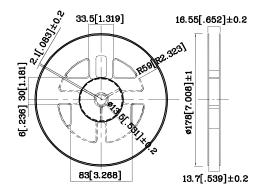
❖ The device has a single mounting surface. The device must be mounted according to the specifications.



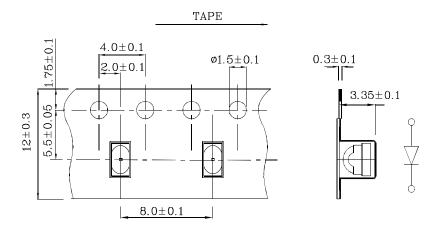
❖ Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



❖ Reel Dimension



❖ Tape Specification (Units:mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

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PACKING & LABEL SPECIFICATIONS

